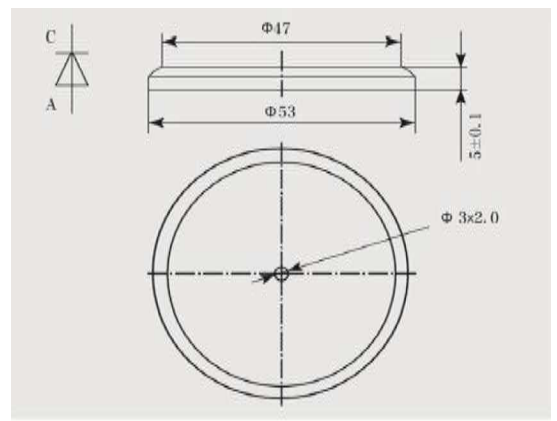


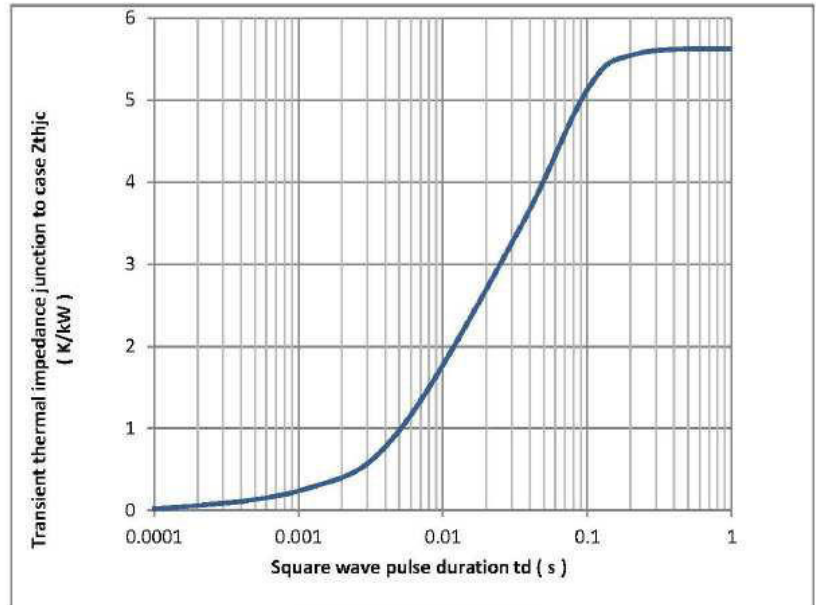
SCD9200

Housingless Diode



Features

- Optimized for high current rectifiers
- Very low threshold voltage and slope resistance
- Very low thermal resistance
- Direct paralleling
- Direct apply 2KHz



Dependence transient thermal impedance junction to case on square pulse

BLOCKING

Symbol	Characteristic	Conditions	T _j (°C)	Value	Unit
V _{RRM}	Repetitive peak reverse voltage	Half sine wave, T _p =10ms f=50Hz		200-400	V
I _{RRM}	Repetitive peak reverse current	V= V _{RRM}	175	50	mA

CONDUCTING

I _{F(AVM)}	Mean forward current	Half sine wave, T _c =85°C		9200	A
I _{FRMS}	Max RMS on-state current	Half sine wave, T _c =85°C		11763	A
I _{FSM}	Max peak non-repetitive current	t _p =10ms, T _j =175°C V _r ~0V		60000	A
I ² t	Max surge current integral			17049K	A ² s
V _F	Maximum on-state voltage	I _F = 8000A	25	0.92÷1.05	V
V _{FO}	Threshold voltage	I _F = 7-21KA	175	0.78	V
r _F	Forward slope resistance	I _F = 7-21KA	175	0.031	mΩ

MOUNTING

R _{th(j-c)}	Thermal impedance, sin 180°	Junction to case		≤5.6K	K/W
R _{th(c-h)}	Thermal impedance	Case to heatsink		≤2.8K	K/W
T _j	Max. junction temperature			-40 175	°C
T _{stg}	Storage temperature			-40 175	°C
M	Mounting torque			30÷50	KN
W	Weight (Approx.)			100	g

Scomes srl reserves the right to change any specification without notice